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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	68 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	A/D 4x8b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c711-20-so

Email: info@E-XFL.COM

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1.0 GENERAL DESCRIPTION

The PIC16C71X is a family of low-cost, high-performance, CMOS, fully-static, 8-bit microcontrollers with integrated analog-to-digital (A/D) converters, in the PIC16CXX mid-range family.

All PIC16/17 microcontrollers employ an advanced RISC architecture. The PIC16CXX microcontroller family has enhanced core features, eight-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 14-bit wide instruction word with the separate 8-bit wide data. The two stage instruction pipeline allows all instructions to execute in a single cycle, except for program branches which require two cycles. A total of 35 instructions (reduced instruction set) are available. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance.

PIC16CXX microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in their class.

The **PIC16C710/71** devices have 36 bytes of RAM, the **PIC16C711** has 68 bytes of RAM and the **PIC16C715** has 128 bytes of RAM. Each device has 13 I/O pins. In addition a timer/counter is available. Also a 4-channel high-speed 8-bit A/D is provided. The 8-bit resolution is ideally suited for applications requiring low-cost analog interface, e.g. thermostat control, pressure sensing, etc.

The PIC16C71X family has special features to reduce external components, thus reducing cost, enhancing system reliability and reducing power consumption. There are four oscillator options, of which the single pin RC oscillator provides a low-cost solution, the LP oscillator minimizes power consumption, XT is a standard crystal, and the HS is for High Speed crystals. The SLEEP (power-down) feature provides a power saving mode. The user can wake up the chip from SLEEP through several external and internal interrupts and resets. A highly reliable Watchdog Timer with its own on-chip RC oscillator provides protection against software lock-up.

A UV erasable CERDIP packaged version is ideal for code development while the cost-effective One-Time-Programmable (OTP) version is suitable for production in any volume.

The PIC16C71X family fits perfectly in applications ranging from security and remote sensors to appliance control and automotive. The EPROM technology makes customization of application programs (transmitter codes, motor speeds, receiver frequencies, etc.) extremely fast and convenient. The small footprint packages make this microcontroller series perfect for all applications with space limitations. Low cost, low power, high performance, ease of use and I/O flexibility make the PIC16C71X very versatile even in areas where no microcontroller use has been considered before (e.g. timer functions, serial communication, capture and compare, PWM functions and coprocessor applications).

1.1 Family and Upward Compatibility

Users familiar with the PIC16C5X microcontroller family will realize that this is an enhanced version of the PIC16C5X architecture. Please refer to Appendix A for a detailed list of enhancements. Code written for the PIC16C5X can be easily ported to the PIC16CXX family of devices (Appendix B).

1.2 Development Support

PIC16C71X devices are supported by the complete line of Microchip Development tools.

Please refer to Section 10.0 for more details about Microchip's development tools.

		PIC16C710	PIC16C71	PIC16C711	PIC16C715	PIC16C72	PIC16CR72 ⁽¹⁾
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
	EPROM Program Memory (x14 words)	512	1K	1K	2K	2К	—
Memory	ROM Program Memory (14K words)	_	_	_	_	_	2K
	Data Memory (bytes)	36	36	68	128	128	128
	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/PWM Module(s)		—	_		1	1
	Serial Port(s) (SPI/I ² C, USART)	_		_	_	SPI/I ² C	SPI/I ² C
	Parallel Slave Port	_	—	—	_	—	—
	A/D Converter (8-bit) Channels	4	4	4	4	5	5
	Interrupt Sources	4	4	4	4	8	8
	I/O Pins	13	13	13	13	22	22
	Voltage Range (Volts)	2.5-6.0	3.0-6.0	2.5-6.0	2.5-5.5	2.5-6.0	3.0-5.5
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	—	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC, SSOP

TABLE 1-1: PIC16C71X FAMILY OF DEVICES

		PIC16C73A	PIC16C74A	PIC16C76	PIC16C77
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20
Memory	EPROM Program Memory (x14 words)	4K	4K	8K	8K
	Data Memory (bytes)	192	192	376	376
	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/PWM Module(s)	2	2	2	2
	Serial Port(s) (SPI/I ² C, USART)	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART
	Parallel Slave Port	—	Yes	—	Yes
	A/D Converter (8-bit) Channels	5	8	5	8
	Interrupt Sources	11	12	11	12
	I/O Pins	22	33	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes
reatures	Brown-out Reset	Yes	Yes	Yes	Yes
	Packages	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C7XX Family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local Microchip sales office for availability of these devices.

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16CXX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16CXX uses a Harvard architecture, in which, program and data are accessed from separate memories using separate buses. This improves bandwidth over traditional von Neumann architecture in which program and data are fetched from the same memory using the same bus. Separating program and data buses further allows instructions to be sized differently than the 8-bit wide data word. Instruction opcodes are 14-bits wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A twostage pipeline overlaps fetch and execution of instructions (Example 3-1). Consequently, all instructions (35) execute in a single cycle (200 ns @ 20 MHz) except for program branches.

The table below lists program memory (EPROM) and data memory (RAM) for each PIC16C71X device.

Device	Program Memory	Data Memory		
PIC16C710	512 x 14	36 x 8		
PIC16C71	1K x 14	36 x 8		
PIC16C711	1K x 14	68 x 8		
PIC16C715	2K x 14	128 x 8		

The PIC16CXX can directly or indirectly address its register files or data memory. All special function registers, including the program counter, are mapped in the data memory. The PIC16CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16CXX simple yet efficient. In addition, the learning curve is reduced significantly.

PIC16CXX devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between the data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register). The other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow bit and a digit borrow out bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

4.2.2.6 PCON REGISTER

Applicable Devices71071711715

The Power Control (PCON) register contains a flag bit to allow differentiation between a Power-on Reset (POR) to an external MCLR Reset or WDT Reset. Those devices with brown-out detection circuitry contain an additional bit to differentiate a Brown-out Reset (BOR) condition from a Power-on Reset condition. For the PIC16C715 the PCON register also contains status bits MPEEN and PER. MPEEN reflects the value of the MPEEN bit in the configuration word. PER indicates a parity error reset has occurred. Note: BOR is unknown on Power-on Reset. It must then be set by the user and checked on subsequent resets to see if BOR is clear, indicating a brown-out has occurred. The BOR status bit is a don't care and is not necessarily predictable if the brown-out circuit is disabled (by clearing the BODEN bit in the Configuration word).

FIGURE 4-12: PCON REGISTER (ADDRESS 8Eh), PIC16C710/711



FIGURE 4-13: PCON REGISTER (ADDRESS 8Eh), PIC16C715

R-U	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-q				
MPEEN		—	—	—	PER	POR	BOR ⁽¹⁾	R = Readable bit			
bit7						 W = Writable bit U = Unimplemented bit, read as '0' n = Value at POR reset 					
bit 7: MPEEN: Memory Parity Error Circuitry Status bit Reflects the value of configuration word bit, MPEEN											
bit 6-3:	Unimplemented: Read as '0'										
bit 2:	 PER: Memory Parity Error Reset Status bit 1 = No Error occurred 0 = Program Memory Fetch Parity Error occurred (must be set in software after a Parity Error Reset) 										
bit 1:	 bit 1: POR: Power-on Reset Status bit 1 = No Power-on Reset occurred 0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs) 										
bit 0:	 BOR: Brown-out Reset Status bit 1 = No Brown-out Reset occurred 0 = A Brown-out Reset occurred (must be set in software after a Brown-out Reset occurs) 										

7.0 ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

Applicable Devices 710 71 711 715

The analog-to-digital (A/D) converter module has four analog inputs.

The A/D allows conversion of an analog input signal to a corresponding 8-bit digital number (refer to Application Note AN546 for use of A/D Converter). The output of the sample and hold is the input into the converter, which generates the result via successive approximation. The analog reference voltage is software selectable to either the device's positive supply voltage (VDD) or the voltage level on the RA3/AN3/VREF pin. The A/D converter has a unique feature of being able to operate while the device is in SLEEP mode. To operate in sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

The A/D module has three registers. These registers are:

- A/D Result Register (ADRES)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)

The ADCON0 register, shown in Figure 7-1 and Figure 7-2, controls the operation of the A/D module. The ADCON1 register, shown in Figure 7-3 configures the functions of the port pins. The port pins can be configured as analog inputs (RA3 can also be a voltage reference) or as digital I/O.

R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
ADCS1	ADCS0	(1)	CHS1	CHS0	GO/DONE	ADIF	ADON	R = Readable bit		
bit7	1						bit0	W = Writable bit U = Unimplemented bit. read as '0'		
								- n =Value at POR reset		
bit 7-6:	ADCS1:A	DCS0: A/D	Conversi	on Clock S	Select bits					
	00 = FOS	C/2								
	10 = FOS	c/32								
	11 = FRC	(clock deriv	ed from a	n RC oscil	lation)					
bit 5:	Unimple	mented: Re	ad as '0'.							
bit 4-3:	CHS1:CHS0: Analog Channel Select bits 00 = channel 0, (RA0/AN0) 01 = channel 1, (RA1/AN1) 10 = channel 2, (RA2/AN2) 11 = channel 3 (RA3/AN3)									
bit 2:	GO/DON	E: A/D Con	version Sta	atus bit						
	If ADON = 1: $1 = A/D$ conversion in progress (setting this bit starts the A/D conversion) $0 = A/D$ conversion not in progress (This bit is automatically cleared by hardware when the A/D conversion is complete)									
bit 1:	ADIF: A/E 1 = conve 0 = conve	D Conversio ersion is con ersion is not	n Comple nplete (mu complete	te Interrup ist be clea	t Flag bit red in softwar	e)				
bit 0:	ADON: A	/D On bit								
	1 = A/D c 0 = A/D c	onverter mo onverter mo	odule is op odule is sh	erating utoff and o	consumes no	operating	current			
Note 1:	Bit5 of Al	DCON0 is a nented, read	l General I d as '0'.	Purpose R	R/W bit for the	PIC16C71	0/711 only. F	For the PIC16C71, this bit is		
	ampen	ionieu, iea								

FIGURE 7-1: ADCON0 REGISTER (ADDRESS 08h), PIC16C710/71/711

7.9 <u>Transfer Function</u>

The ideal transfer function of the A/D converter is as follows: the first transition occurs when the analog input voltage (VAIN) is Analog VREF/256 (Figure 7-6).

7.10 <u>References</u>

A very good reference for understanding A/D converters is the "Analog-Digital Conversion Handbook" third edition, published by Prentice Hall (ISBN 0-13-03-2848-0).



ADON = 0Yes ADON = 0 No Acquire Selected Channel Yes GO = 0? No Start of A/D onversion Delaye Instruction Cycle Yes A/D Clock = RC? /es SLEEP Finish Conversior Inst uction GO = 0 ADIF = 1 No No Yes Abort Conversion Yes Wake-up From Sleep inish Conversio Device in SLEEP? Wait 2 TAD GO = 0ADIF = 0 GO = 0 ADIF = 1 No No SLEEP Power-down A/D Finish Conversion Stay in Sleep Power-down A/D Wait 2 TAD GO = 0 ADIF = 1 Wait 2 TAD

FIGURE 7-7: FLOWCHART OF A/D OPERATION

RETLW	Return with Literal in W							
Syntax:	[label]	RETLW	k					
Operands:	$0 \le k \le 255$							
Operation:	$\begin{array}{l} k \rightarrow (W); \\ TOS \rightarrow P \end{array}$	9C						
Status Affected:	None							
Encoding:	11	01xx	kkkk	kkkk				
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two cycle instruction.							
Words:	1							
Cycles:	2							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
1st Cycle	Decode	Read literal 'k'	NOP	Write to W, Pop from the Stack				
2nd Cycle	NOP	NOP	NOP	NOP				
Example	CALL TABLE ;W contains table ;offset value • ;W now has table value •							
TABLE	TABLE ADDWF PC ;W = offset RETLW k1 ;Begin table RETLW k2 ;							
	RETLW kn ; End of table							
		Siluciion W =	0x07					
	After Inst	ruction		-				
		VV =	value of k	8				

Return from Subroutine							
[label] RETURN							
None							
$\text{TOS} \to \text{F}$	°C						
None							
00	0000	0000	1000				
Return fro POPed an is loaded i This is a tw	m subrou d the top nto the pr vo cycle i	tine. The s of the stac ogram cou nstruction.	tack is k (TOS) ınter.				
1							
2							
Q1	Q2	Q3	Q4				
Decode	NOP	NOP	Pop from the Stack				
NOP	NOP	NOP	NOP				
RETURN After Inte	rrupt PC =	TOS					
	Return fr [<i>label</i>] None TOS → F None 00 Return fro POPed an is loaded i This is a tw 1 2 Q1 Decode NOP RETURN After Inte	Return from Sub[label]RETURNoneTOS \rightarrow PCNone00000000Return from subrouPOPed and the topis loaded into the prThis is a two cycle i12Q1Q2DecodeNOPNOPNOPRETURNAfter InterruptPC=	Return from Subroutine[label]RETURNNoneTOS \rightarrow PCNone000000000000000Return from subroutine. The sPOPed and the top of the stactist loaded into the program couthis is a two cycle instruction.12Q1Q2Q3DecodeNOPNOPNOPNOPNOPRETURNAfter Interrupt PC = TOS				

PIC16C71X

Appli	cable Devices	710 71	711 715
11.1	DC Character	ristics:	PIC16C710-04 (Commercial, Industrial, Extended) PIC16C711-04 (Commercial, Industrial, Extended) PIC16C710-10 (Commercial, Industrial, Extended) PIC16C711-10 (Commercial, Industrial, Extended) PIC16C710-20 (Commercial, Industrial, Extended)
			PIC16C711-20 (Commercial, Industrial, Extended)

DC CHA	RACTERISTICS		Standard Operating Con Operating temperature (-				ditions (unless otherwise stated) $0^{\circ}C$ $\leq TA \leq +70^{\circ}C$ (commercial) $-40^{\circ}C$ $\leq TA \leq +85^{\circ}C$ (industrial) $-40^{\circ}C$ $\leq TA \leq +125^{\circ}C$ (extended)		
Param. No.	Characteristic	Sym	Min	Тур†	Мах	Units	Conditions		
D001 D001A	Supply Voltage	Vdd	4.0 4.5		6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration		
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V			
D003	VDD start voltage to ensure internal Power- on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details		
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details		
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN configuration bit is enabled		
			3.7	4.0	4.4	V	Extended Range Only		
D010	Supply Current (Note 2)	IDD	-	2.7	5	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 5.5V (Note 4)		
D013			-	13.5	30	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V		
D015	Brown-out Reset Current (Note 5)	ΔIBOR	-	300*	500	μA	BOR enabled VDD = 5.0V		
D020	Power-down Current	IPD	-	10.5	42	μA	$VDD = 4.0V$, WDT enabled, $-40^{\circ}C$ to $+85^{\circ}C$		
D021	(Note 3)		-	1.5	21	μΑ	VDD = $4.0V$, WDT disabled, $-0^{\circ}C$ to $+70^{\circ}C$		
D021A D021B			-	1.5	30	μΑ μΑ	$VDD = 4.0V$, VDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$ $VDD = 4.0V$, WDT disabled, $-40^{\circ}C$ to $+125^{\circ}C$		
D023	Brown-out Reset Current (Note 5)	ΔIBOR	-	300*	500	μA	BOR enabled VDD = 5.0V		

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDDMCLR = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.



FIGURE 11-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

FIGURE 11-5: BROWN-OUT RESET TIMING



TABLE 11-4:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER,
AND BROWN-OUT RESET REQUIREMENTS

Parameter	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
No.							
30	TmcL	MCLR Pulse Width (low)	1	_	—	μs	VDD = 5V, -40°C to +125°C
31	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7*	18	33*	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	_	1024Tosc	—	-	Tosc = OSC1 period
33	Tpwrt	Power up Timer Period	28*	72	132*	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or Watchdog Timer Reset	_	_	1.1	μs	
35	TBOR	Brown-out Reset pulse width	100	—	—	μs	$3.8V \leq VDD \leq 4.2V$

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 12-12: TYPICAL IDD vs. FREQUENCY (RC MODE @ 22 pF, 25°C)





FIGURE 12-13: MAXIMUM IDD vs. FREQUENCY (RC MODE @ 22 pF, -40°C TO 85°C)

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FIGURE 12-23: TYPICAL XTAL STARTUP TIME vs. VDD (HS MODE, 25°C)



FIGURE 12-24: TYPICAL XTAL STARTUP TIME vs. VDD (XT MODE, 25°C)



TABLE 12-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATORS

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15-33 pF	15-33 pF
	20 MHz	15-33 pF	15-33 pF
		•	
Crystals Used			
32 kHz	Epson C-00	± 20 PPM	
200 kHz	STD XTL 2	± 20 PPM	
1 MHz	ECS ECS-	± 50 PPM	
4 MHz	ECS ECS-4	± 50 PPM	
8 MHz	EPSON CA	± 30 PPM	
20 MHz	EPSON CA	± 30 PPM	

PIC16C71X

Applicable Devices 710 71 711 715



FIGURE 13-3: CLKOUT AND I/O TIMING

TABLE 13-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter	Sym	Characteristic	. <	Min	Typ†	Max	Units	Conditions
No.			$ \longrightarrow $	\searrow				
10*	TosH2ckL	OSC1↑ to CLKOUT↓		\searrow	15	30	ns	Note 1
11*	TosH2ckH	OSC1 [↑] to CLKOUT [↑]	$\langle \rangle \rangle$	<u> </u>	15	30	ns	Note 1
12*	TckR	CLKOUT rise time	/ / / / /	V –	5	15	ns	Note 1
13*	TckF	CLKOUT fall time	$\land \land $	—	5	15	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valio	$\land \land \lor$		_	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOU	Т	0.25Tcy + 25	_	—	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT	0	—	—	ns	Note 1	
17*	TosH2ioV	OSC11 (Q1) cycle) to		—	_	80 - 100	ns	
		Port out valid						
18*	TosH2iol	OSC1 (Q2 cycle) to		TBD	—	—	ns	
		Port input invalid (1/9 in hol	d time)					
19*	TioV20sH	Port input valid to OSC11 (I/O in setup time)	TBD	_	—	ns	
20*	TioR	Port output rise time	PIC16C715	—	10	25	ns	
	$ \setminus \vee$	\land	PIC16LC715		_	60	ns	
21*	Tior	Port output fall time	PIC16C715	—	10	25	ns	
	$\left[\right) \right)$	\triangleright	PIC16LC715	—	—	60	ns	
22	Tinp	INT pin high or low time		20	—	—	ns	
23††*	Trisp	RB7:RB4 change INT high	or low time	20	—	_	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

these parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

FIGURE 13-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, AND POWER-UP TIMER TIMING





TABLE 13-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET REQUIREMENTS

Parameter	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
No.	$ \setminus \lor $	$\langle \frown \rangle$					
30	TmcL	MCLR Pulse Width (low)	2	—	_	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	< Tost	Oscillation Start-up Timer Period	—	1024Tosc		—	Tosc = OSC1 period
33*	Tpwrt	Power up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tioz	I/O Hi-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.1	μs	
35	TBOR	Brown-out Reset pulse width	100	—		μs	$VDD \le BVDD (D005)$
36	TPER	Parity Error Reset		TBD	_	μs	

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 13-7: A/D CONVERSION TIMING



TABLE 13-8: A/D CONVERSION REQUIREMENTS

Parameter	Sym	Characteristic	Min	Typt/	Max	Units	Conditions
No.							
130	TAD	A/D clock period	1.6	$\langle // /$	× _	μs	VREF ≥ 3.0V
			2.0			μs	VREF full range
130	TAD	A/D Internal RC		$\land \lor$			ADCS1:ADCS0 = 11
		Oscillator source		$\langle \rangle$			(RC oscillator source)
		$\langle \rangle$	3.0	6.0	9.0	μs	PIC16LC715, VDD = 3.0V
		$ \land \land$	2.0	4.0	6.0	μs	PIC16C715
131	TCNV	Conversion time		9.5TAD	—	—	
		(not including S/H	\sim				
		time). Note [*] 1	12				
132	TACQ	Acquisition time	Note 2	20	_	μs	

* These parameters are characterized but not tested.

† Data in Type column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: ADRES register may be read on the following TCY cycle.

FIGURE 14-12: TYPICAL IDD vs. FREQUENCY (RC MODE @ 22 pF, 25°C)











TABLE 14-1: RC OSCILLATOR FREQUENCIES

FIGURE 14-18: TYPICAL IDD vs.

Coxt	Port	Average		
CEXI	NEXI	Fosc @ 5V, 25°C		
22 pF	5k	4.12 MHz	± 1.4%	
	10k	2.35 MHz	± 1.4%	
	100k	268 kHz	±1,1%	
100 pF	3.3k	1.80 MHz	±1.0%	
	5k	1.27 MHz	± 1.0%	
	10k	688 KHz	± 1.2%	
	100k	77.2 kHz	± 1.0%	
300 pF	3.3k	707 kHz	± 1.4%	
	5k	501 kHz /	± 1.2%	
	10k	269 kHz	± 1.6%	
	100k	28.3 kHz	± 1.1%	

The percentage variation-indicated here is part to part variation due to normal process distribution. The variation indicated is ± 3 standard deviation from average value for VDD = 5V.



FIGURE 14-20: TRANSCONDUCTANCE(gm) OF LP OSCILLATOR vs. VDD



FIGURE 14-21: TRANSCONDUCTANCE(gm) OF XT OSCILLATOR vs. VDD





$\ensuremath{\textcircled{}^{\odot}}$ 1997 Microchip Technology Inc.

TO bit	
TOSE bit	
TRISA Register	
TRISB Register	
Two's Complement	7
U	

0	
Upward Compatibility	
UV Erasable Devices	

W

W Register	
ALU	7
Wake-up from SLEEP	
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WDT	
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Timeout	
WDT Period	
WDTE bit	
Z	

Z bit .		
Zero b	bit	7

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